

**NONPROVISIONAL PATENT  
APPLICATION TRANSMITTAL RULE §1.53(b)  
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Customer No. 004372  
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Docket No. 108384-00034  
Date: November 30, 2001

Commissioner for Patents  
Washington, D.C. 20231

Sir:

Transmitted herewith for filing under 37 C.F.R. §1.53(b) is a nonprovisional patent application:

For (Title): RESIN COMPOUND FOR FABRICATING INTERLAYER DIELECTRIC OF  
PRINTED WIRING BOARD, RESIN SHEET AND RESIN APPLIED-  
COPPER FOIL FOR FORMING INSULATING LAYER USING THE RESIN  
COMPOUND, AND COPPER-CLAD LAMINATE USING THEM

By (Inventors): Tetsuro SATO and Tsutomu ASAI

- ☒ 33 pages of Specification/Claims 1-12/Abstract are attached.
- ☒ A Declaration and Power of Attorney is attached.
- ☒ An assignment of the invention to Mitsui Mining & Smelting Co., Ltd. is attached, along with Form PTO-1595 and a check for \$40.00.
- ☒ A Preliminary Amendment is attached.
- ☒ Priority of foreign application No. 2000-374070 filed December 8, 2000 in Japan is claimed under 35 U.S.C. §119.
- ☒ A certified copy of the above corresponding foreign application is attached.

The filing fee is calculated below and includes claim status after entry of any Preliminary Amendment noted above:

			SMALL ENTITY			LARGE ENTITY	
FOR:	NO. FILED	NO. EXTRA	RATE	FEE	OR	RATE	FEE
BASIC FEE				\$ 370	OR		\$ 740
TOTAL CLAIMS	12 - 20	= 0	x 9 =	\$	OR	x 18	\$
INDEP CLAIMS	1 - 3	= 0	x 42 =	\$	OR	x 84	\$
<input type="checkbox"/> MULTIPLE DEPENDENT CLAIMS			+140 =	\$	OR	+280	\$
			TOTAL	\$	OR	TOTAL	\$ 740

- ☒ A check in the amount of \$780.00 (\$740.00 for the filing fee and \$40.00 for the Assignment Recordation Fee) is attached. Please charge any fee deficiency or credit any overpayment to Deposit Account No. 01-2300.

Respectfully submitted,

  
Robert B. Murray

Registration No. 22,980

RBM//ars